



南京华鼎电子有限公司
中国·南京市江宁区汤山镇

Tel: 025-84107685

Fax: 025-84107684

E-mail: servicehd@paralight.com.cn

DATA SHEET

PART NO. : B-1408G

REV : A/0

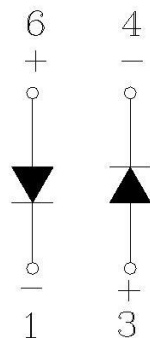
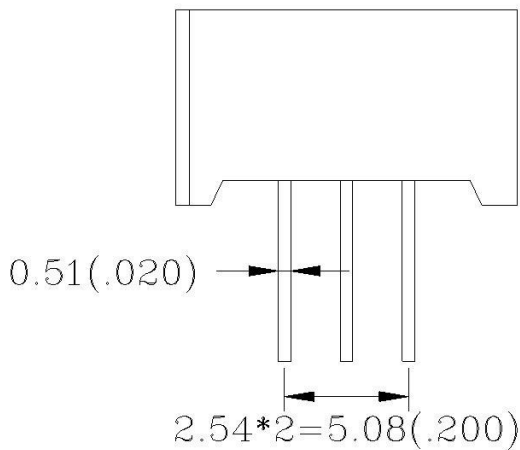
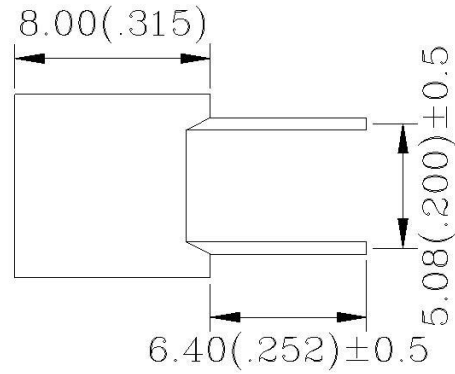
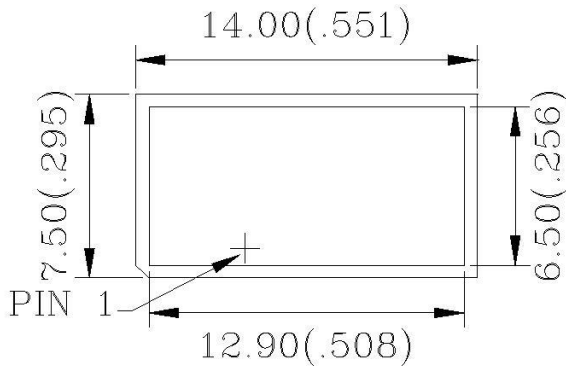
CUSTOMER'S APPROVAL : _____ DCC : _____

DRAWING NO. : DS-17-06-0067

DATE : 2006-10-27

Page : 1

PACKAGE DIMENSIONS



2 NO PIN
5 NO CONNECT

NOTES : 1. All dimensions are in millimeters. (inches)
2. Tolerance is $\pm 0.25(0.010)$ unless otherwise specified.



6.5 mm x 12.9 mm SQUARE LIGHT BAR

B-1408G

REV:A / 0

FEATURES

- 6.5 X 12.90mm SQUARE LIGHT BAR
- LOW POWER REQUIREMENT
- CAN BE USED WITH PANEL AND LEGEND MOUNT
- SUITABLE FOR MULTIPLEX OPERATION
- EASY MOUNTING ON P.C.B
- Pb FREE PRODUCTS
- GREEN SEGMENTS

Raw Material :GaP/GaP

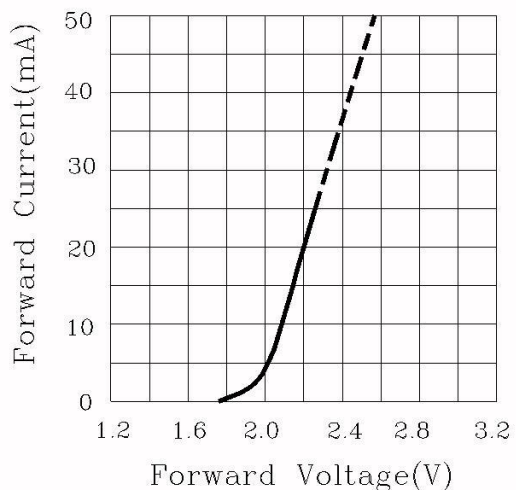
ABSOLUTE MAXIMUM RATING : (Ta = 25°C)

SYMBOL	PARAMETER	YELLOW GREEN	UNIT
PD	Power Dissipation Per Bar	75	mW
VR	Reverse Voltage Per Bar	5	V
IAF	Continuous Forward Current Per Bar	25	mA
—	Derating Linear From 25°C Per Bar	0.33	mA/°C
Topr	Operating Temperature Range	-35°C to 85°C Tstg	
	Storage Temperature Range	-35°C to 85°C	

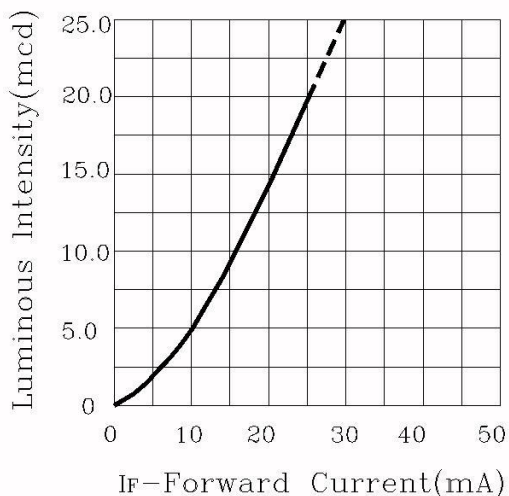
ELECTRO-OPTICAL CHARACTERISTICS : (Ta = 25°C)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Forward Voltage , Per Bar	IF = 20mA		2.2	2.8	V
IR	Reverse Current , Per Bar	VR = 5V			100	µA
λP	Peak Emission Wavelength	IF = 20mA		568		nm
λD	Dominant Wavelength	IF = 20mA		570		nm
Δλ	Spectral Line Half—Width	IF = 20mA		30		nm
IV	Luminous Intensity Per Bar	IF = 10mA	2.0	5.0		mcd

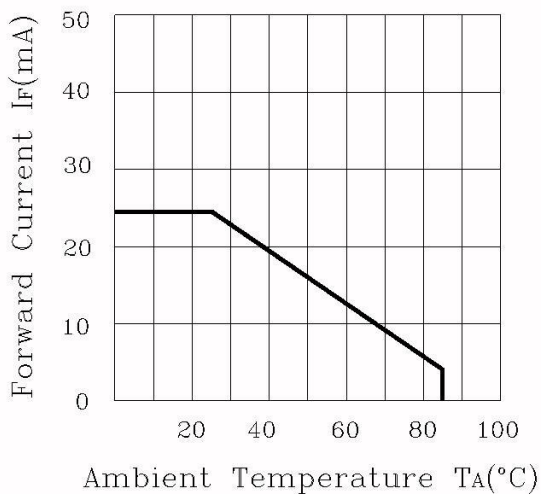
FORWARD CURRENT Vs.
FORWARD VOLTAGE



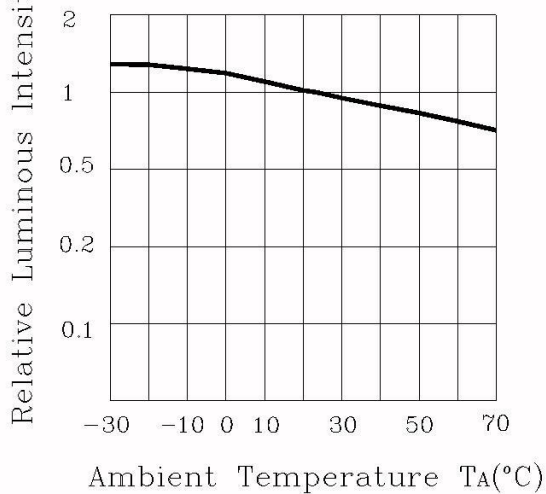
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SOLDERING

METHOD	SOLDERING CONDITIONS	REMARK
DIP SOLDERING	Bath temperature: 260 max Immersion time: within 5 sec	Solder no closer than 2mm from the base of the package Using soldering flux, "RESIN FLUX" is recommended.
SOLDERING IRON	Soldering iron: 30W or smaller Temperature at tip of iron: 260°C or lower	During soldering, take care not to press the tip of iron against the PIN.

Soldering time: within 5 sec.

(To prevent heat from being transferred directly to the PIN.)

- 1) When soldering the PIN of Display in a jig that the package is fixed with a panel (See fig.1), be careful not to stress the PIN with iron tip. When soldering Display in a condition that the package is fixed with a panel, be careful not to cling and stress the surface of Display on the panel to avoid damaging the Display.

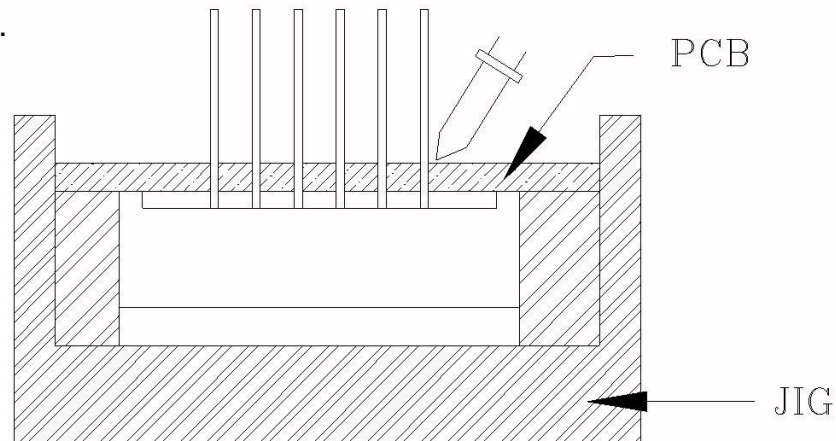


Fig.1

Regarding solution in the tinning oven for product-tinning, compound sub-solution made of tin & copper and silver is proposed with the temperature of Celsius 260. The proportion of the alloyed solution is tin 95.5: copper 3.5: silver 0.5 by percentage. The time of tinning is constantly 3 seconds.